

20 PCS TRAY

JEDEC SOLID STATE  
PRODUCT OUTLINE  
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AND REFLECTS A PRODUCT WITH ANTICIPATED USAGE IN THE ELECTRONICS INDUSTRY;  
CHANGES ARE LIKELY TO OCCUR.

TITLE

SHIPPING AND  
HANDLING TRAY  
FOR DDR5 2U DIMM

PACKAGE DESIGNATOR

N/A

ITEM

CO-042

ISSUE

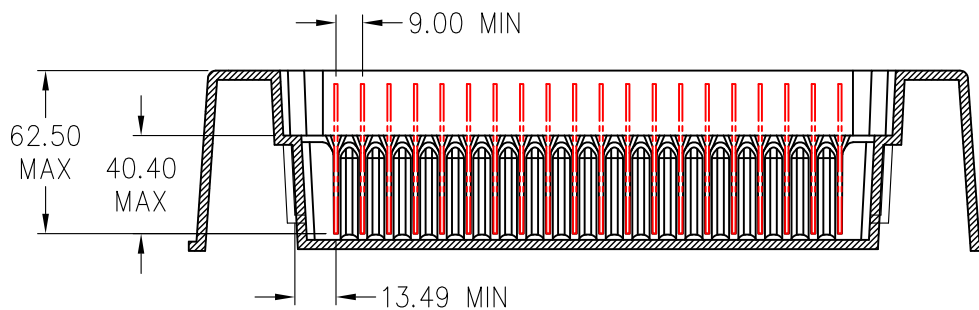
A

DATE

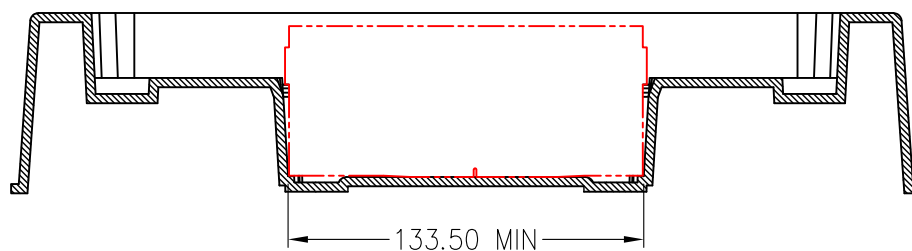
FEB 2025

SHEET

1 OF 5

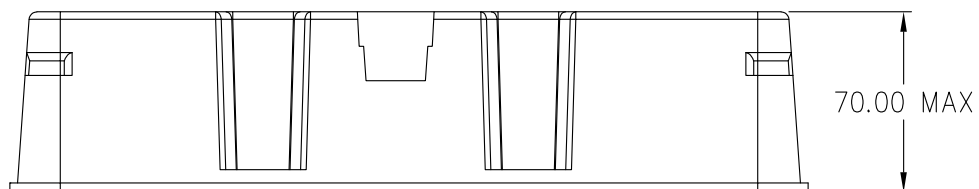
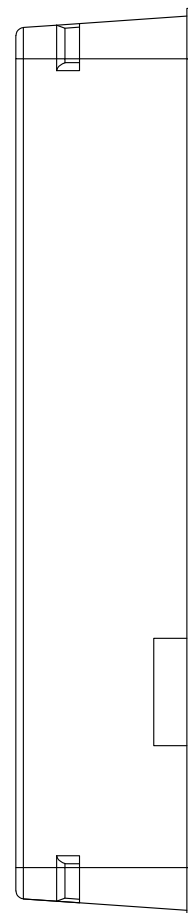
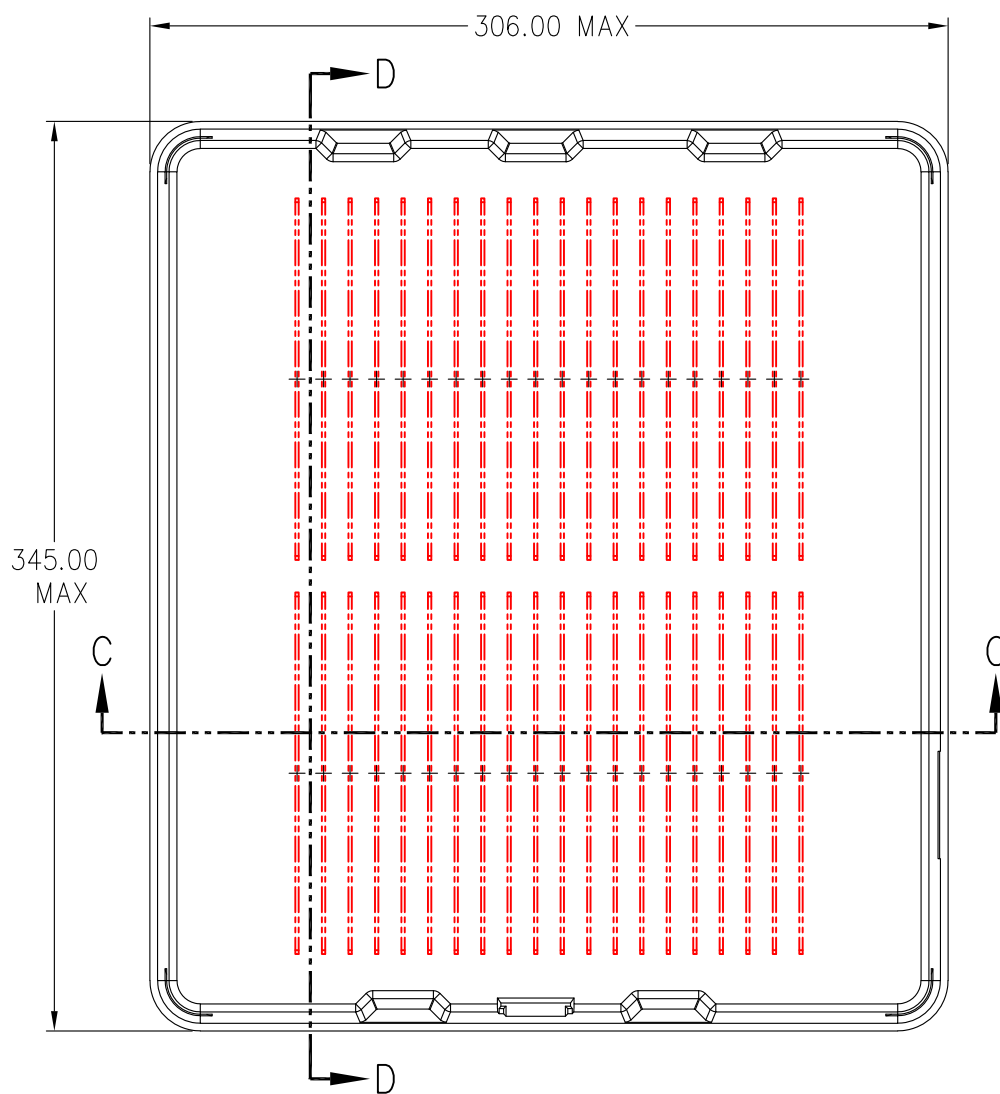


SECTION A-A

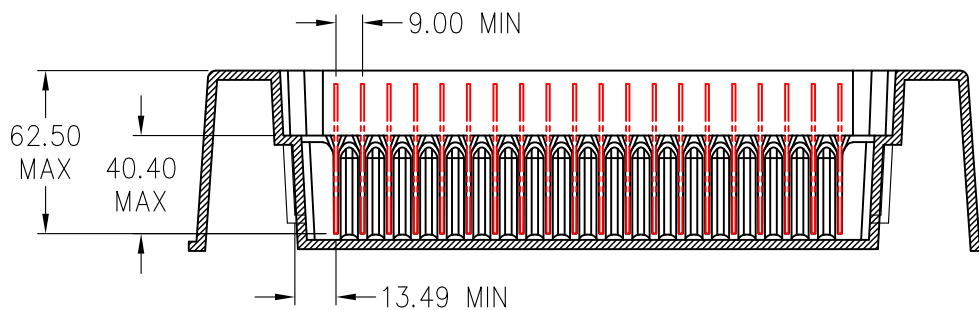


SECTION B-B

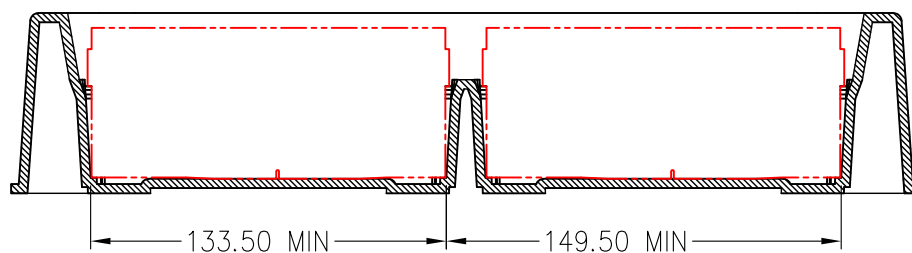
20 PCS TRAY



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SECTION C-C



SECTION D-D

40 PCS TRAY

NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5–2009.
2. ALL DIMENSIONS ARE MILLIMETERS.
3. THIS TRAY IS DESIGNED SPECIFICALLY TO FIT MO–329 DDR5 2U DIMM, 0.85 PITCH MICROELECTRONIC ASSEMBLY.
4. QUANTITY PER TRAY IS OPTIONAL – 20 PCS OR 40 PCS.
5. FOR 40 PCS ONLY,  
TWO SLOTS APPLIED AND THE LENGTH SLOT + MID RIB IS 149.50 MIN.
6. THE TRAY COVER IS RECOMMENDED TO HAVE RIDGES TO SECURE THE TOP OF THE DIMM.
7. THE TRAY COVER IS NOT INCLUDED IN THE DRAWING.

STP (3D) FILE RECORD

3D FILE NAMES MAY EXCEED LENGTH REQUIREMENTS FOR SOME SOFTWARE TOOLS.

STP FILE NAME	DATE	ITEM NUMBER
CO-042A_SHIPPING AND HANDLING TRAY FOR DDR5 2U DIMM (20PCS)	FEB 2025	5-1074
CO-042A_SHIPPING AND HANDLING TRAY FOR DDR5 2U DIMM (40PCS)	FEB 2025	5-1074

## TASK GROUP CONTRIBUTORS

AMPHENOL CORPORATION  
DELL INC.  
HP INC.  
INTEL CORPORATION  
LENOVO  
LOTES CO., LTD  
MICRON TECHNOLOGY  
RAMAXEL TECHNOLOGY  
SAMSUNG SEMICONDUCTOR  
SK HYNIX

CHANGE RECORD

IF THE CHANGE INVOLVES ANY WORDS ADDED OR DELETED (EXCLUDING DELETION OF ACCIDENTALLY REPEATED WORDS), THE CHANGE IS TO BE INCLUDED BELOW. PUNCTUATION CHANGES MAY OR MAY NOT BE INCLUDED.

INITIAL ISSUE: A	DATE: FEBRUARY 2025	ITEM NUMBER: 5-1074
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CHANGE RECORD HISTORY:
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ISSUE:	DATE:	ITEM NUMBER:
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LOCATION:	CHANGED FROM:	CHANGED TO: